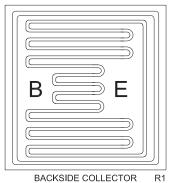


# **CP714V-MJE172**

# PNP - High Current Transistor Die 3.0 Amp, 80 Volt

The CP714V-MJE172 is a silicon PNP transistor designed for high current applications.

**MECHANICAL SPECIFICATIONS:** 



Die Size	40.2 x 40.2 MILS
Die Thickness	7.1 MILS
Base Bonding Pad Size	7.9 x 8.7 MILS
Emitter Bonding Pad Size	9.0 x 14 MILS
Top Side Metalization	AI – 30,000Å
Back Side Metalization	Au – 9,000Å
Scribe Alley Width	1.8 MILS
Wafer Diameter	5 INCHES
Gross Die Per Wafer	10,560

MAXIMUM RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Collector-Base Voltage	$V_{CBO}$	100	V
Collector-Emitter Voltage	$V_{CEO}$	80	V
Emitter-Base Voltage	$V_{EBO}$	7.0	V
Continuous Collector Current	I <sub>C</sub>	3.0	Α
Peak Collector Current	I <sub>CM</sub>	6.0	Α
Continuous Base Current	ΙΒ	1.0	Α
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

	CHARACTERISTICS: (T <sub>A</sub> =25°C)			
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
ICBO	V <sub>CB</sub> =100V		100	nA
I <sub>EBO</sub>	V <sub>EB</sub> =7.0V		100	nA
<b>BV</b> CEO	I <sub>C</sub> =10mA	80		V
V <sub>CE</sub> (SAT)	I <sub>C</sub> =500mA, I <sub>B</sub> =50mA		0.3	V
V <sub>CE</sub> (SAT)	I <sub>C</sub> =1.5A, I <sub>B</sub> =150mA		0.9	V
V <sub>CE(SAT)</sub>	I <sub>C</sub> =3.0A, I <sub>B</sub> =600mA		1.7	V
V <sub>BE</sub> (SAT)	I <sub>C</sub> =1.5A, I <sub>B</sub> =150mA		1.5	V
V <sub>BE(SAT)</sub>	I <sub>C</sub> =3.0A, I <sub>B</sub> =600mA		2.0	V
V <sub>BE(ON)</sub>	$V_{CE}$ =1.0V, $I_{C}$ =500mA		1.2	V
hFE	V <sub>CE</sub> =1.0V, I <sub>C</sub> =100mA	50	250	
h <sub>FE</sub>	V <sub>CE</sub> =1.0V, I <sub>C</sub> =500mA	30		
h <sub>FE</sub>	V <sub>CE</sub> =1.0V, I <sub>C</sub> =1.5A	12		
$f_{T}$	$V_{CE}$ =10V, $I_{C}$ =100mA, f=10MHz	50		MHz
$C_{ob}$	$V_{CB}$ =10V, $I_{E}$ =0, f=100kHz		50	pF

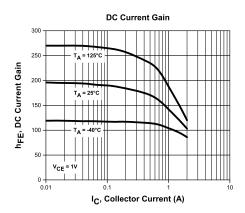
R0 (2-August 2016)

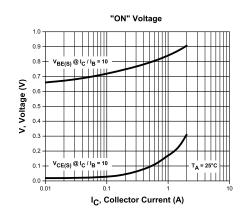
# **CP714V-MJE172**

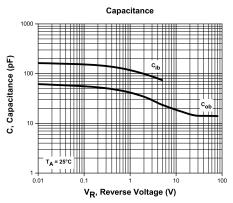
# **Typical Electrical Characteristics**

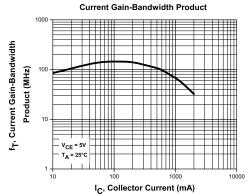


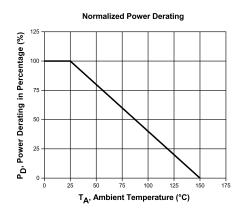
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## BARE DIE PACKING OPTIONS

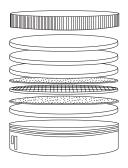




## BARE DIE IN TRAY (WAFFLE) PACK

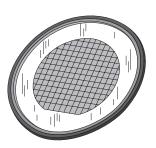
CT: Singulated die in tray (waffle) pack. (example: CP211-PART NUMBER-CT)

CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-PART NUMBER-CM)



## **UNSAWN WAFER**

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



#### SAWN WAFER ON PLASTIC RING

**WR**: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked.

(example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

R2 (3-April 2017)

### **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**



#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### **CONTACT US**

#### Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA

Main Tel: (631) 435-1110 Main Fax: (631) 435-1824

Support Team Fax: (631) 435-3388

www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

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